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PATENT & TRADEMARK OFFICE

2823

PATENT

Atty. Dkt. No. AMAT/2966.X3/DSM/BCVD/JW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Huang, et al. §

Serial No.: 09/270,039 §

Confirmation No.: 1949 §

Filed: March 16, 1999 §

For: In Situ Deposition of a Low K Dielectric Layer, Barrier Layer, Etch Stop Layer and Anti-Reflective Coating for Damascene Application §

Group Art Unit: 2823

Examiner: George R. Fourson, III

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING
37 CFR 1.8

I hereby certify that this correspondence is being deposited on **February 23, 2005**, with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

February 23, 2005 (Date) — (Signature)

RESPONSE TO OFFICE ACTION DATED NOVEMBER 23, 2004

In response to the Office Action dated November 23, 2004, having a shortened statutory period for response set to expire on February 23, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/2966.X3/BKH, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

The pending claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 6 of this paper.